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#### **FEATURES**

- V<sub>TT</sub> Bus Termination Output (Output Tracks the System V<sub>REF</sub>)
- 10 A Output Current
- 3.3-V, 5-V or 12-V Input Voltage
- DDR and QDR Compatible
- On/Off Inhibit (for V<sub>TT</sub> Standby)
- Undervoltage Lockout
- Operating Temperature: –40°C to 85°C
- Efficiencies up to 91%
- Output Overcurrent Protection (Non-Latching, Auto-Reset)

- 57 W/in<sup>3</sup> Power Density
- Safety Agency Approvals: UL/cUL60950, EN60950, VDE
- Point-of-Load Alliance (POLA™) Compatible



NOMINAL SIZE 1 in. x 0.62 in (25,4 mm x 15,75 mm)

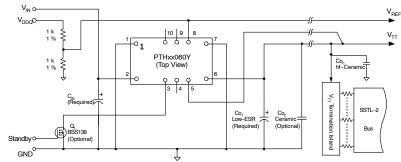
#### DESCRIPTION

The PTHxx060Y are a series of ready-to-use switching regulator modules from Texas Instruments designed specifically for bus termination in DDR and QDR memory applications. Operating from either a 3.3-V, 5-V or 12-V input, the modules generate a  $V_{TT}$  output that will source or sink up to 10 A of current to accurately track their  $V_{REF}$  input.  $V_{TT}$  is the required bus termination supply voltage, and  $V_{REF}$  is the reference voltage for the memory and chipset bus receiver comparators.  $V_{REF}$  is usually set to half the  $V_{DDQ}$  power supply voltage.

Both the PTHxx060Y series employs an actively switched synchronous rectifier output to provide state-of-the-art stepdown switching conversion. The products are small in size (1 in  $\times$  0.62 in), and are an ideal choice where space, performance, and high efficiency are desired, along with the convenience of a ready-to-use module.

Operating features include an on/off inhibit and output over-current protection (source mode only). The on/off inhibit feature allows the  $V_{TT}$  bus to be turned off to save power in a standby mode of operation. To ensure tight load regulation, an output remote sense is also provided. Package options include both throughhole and surface mount configurations.

#### STANDARD APPLICATION



 $C_{IN}$  = Required Capacitor; 330 $\mu$ F (3.3 ± 5 V Input), 560  $\mu$ F (12 V Input).

Co<sub>1</sub> = Required Low-ESR Electrolyitic Capacitor; 470  $\mu$ F (3.3  $\pm$  5 V Input), 940  $\mu$ F (12 V Input).

Co<sub>2</sub> = Ceramic Capacitance for Optimum Response to a 3 A (+ 1.5 A) Load Transient; 200  $\mu$ F (3.3  $\pm$  5 V Input), 400  $\mu$ F (12 V Input).

Co<sub>n</sub> = Distributed hf-Ceramic Decoupling Capacitors for V<sub>TT</sub> bus; as Recommended for DDR Memory Applications

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

POLA is a trademark of Texas Instruments.



#### **ORDERING INFORMATION**

	PTHXX060Y (Base Part Number)											
Input Voltage	Part Number <sup>(1)</sup>	DESCRIPTION	Pb – free and RoHS	Mechanical Package								
	PTH03060YAH	Horizontal T/H	Yes (3)	EUW								
3.3 V	PTH03060YAS	Standard SMD	No <sup>(4)</sup>	EUY								
	PTH03060YAZ	Optional SMD	Yes (3)	EUY								
	PTH05060YAH	Horizontal T/H	Yes (3)	EUW								
5 V	PTH05060YAS	Standard SMD	No <sup>(4)</sup>	EUY								
	PTH05060YAZ	Optional SMD	Yes (3)	EUY								
	PTH12060YAH	Horizontal T/H	Yes (3)	EUW								
12 V	PTH12060YAS	Standard SMD	No <sup>(4)</sup>	EUY								
	PTH12060YAZ	Optional SMD	Yes (3)	EUY								

- Add T to end of part number for tape and reel on SMD packages only.
- (2) Reference the applicable package reference drawing for the dimensions and PC board layout.
   (3) Lead (Pb) –free option specifies Sn/Ag pin solder material.
   (4) Standard option specifies 63/37, Sn/Pb pin solder material.

#### **ENVIRONMENTAL AND ABSOLUTE MAXIMUM RATINGS**

voltages are with respect to GND

				UNIT				
$V_{REF}$	Control input voltage	–0.3 V to V <sub>in</sub> +03 V						
T <sub>A</sub>	Operating temperature range	Over V <sub>IN</sub> range	-40°C to 85°C <sup>(1)</sup>					
T <sub>wave</sub>	Wave solder temperature	Surface temperature of module body or pins (5 seconds)	PTHXX060YAH	260°C <sup>(2)</sup>				
_	Caldan maffann ta man anathura	Conference to a service of an adula hadron since	PTHXX060YAS	235°C (2)				
I reflow	Solder reflow temperature	Surface temperature of module body or pins	PTHXX060YAZ	260°C (2)				
Ts	Storage temperature			–40°C to 125°C				
	Mechanical shock	Per Mil-STD-883D, Method 2002.3 1 msec, 1/2 Sind	e, mounted	500 G				
	Mechanical vibration	Mil-STD-883D, Method 2007.2 20-2000 Hz	Mil-STD-883D, Method 2007.2 20-2000 Hz					
	Weight	3.7 grams						
	Flammability	Meets UL 94V-O						

- (1) For operation below 0°C, the external capacitors must have stable characteristics, use either a low ESR tantalum, Os-Con, or ceramic capacitor.
- During soldering of package version, do not elevate peak temperature of the module, pins or internal components above the stated maximum.



#### **ELECTRICAL SPECIFICATIONS**

 $T_A = 25^{\circ}C$ ; nominal  $V_{IN}$ ;  $V_{REF} = 1.25$  V;  $C_{IN}$ ,  $C_O1$ , and  $C_O2$  = typical values; and  $I_O = I_Omax$  (unless otherwise stated)

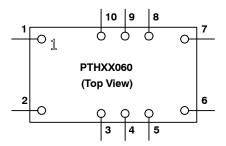
PARAMETER		TEST CON	DITIONS	MIN	TYP	MAX	UNIT	
Io	Output current	Over ΔV <sub>REF</sub> range	Continuous	0		±10 <sup>(1)</sup>	Α	
			PTH03060Y	2.95		3.65		
$V_{IN}$	Input voltage range	Over I <sub>O</sub> range	PTH05060Y	4.5		5.5	V	
			PTH12060Y	10.8		13.2		
$\Delta V_{REF}$	Tracking range for V <sub>REF</sub>		<u> </u>	0.55		1.8	V	
V <sub>TT</sub> V <sub>REF</sub>	Tracking tolerance to V <sub>REF</sub>	Over line, load and temperature		-10		10	mV	
			PTH03060Y		86%			
η	Efficiency	I <sub>o</sub> = 8 A	PTH05060Y		86%			
			PTH12060Y		83%			
V <sub>r</sub>	V <sub>o</sub> Ripple (pk-pk)	20 MHz bandwidth			20		mVpp	
I <sub>o</sub> trip	Overcurrent threshold	Reset, followed by auto recovery			20		Α	
t <sub>tr</sub>		15 A/μs load step, from:	Recovery time		30		μsec	
V <sub>tr</sub>	Load transient response	-1.5 A to 1.5 A	V <sub>O</sub> over/undershoot		25	40	mV	
	<u> </u>		PTH03060Y		2.45	2.8		
		V <sub>IN</sub> Increasing	PTH05060Y		4.3	4.45	V	
			PTH12060Y		9.5	10.4		
UVLO	JVLO Under-voltage lockout		PTH03060Y	2.0	2.40		V	
		V <sub>IN</sub> Dncreasing	PTH05060Y	3.4	3.7			
			PTH12060Y	8.8	9			
V <sub>IH</sub>	Inhibit control (pin 4) Input high voltage	Defendant OND		V <sub>IN</sub> -0.5		Open <sup>(2)</sup>	٧	
V <sub>IL</sub>	Inhibit control (pin 4) Input low voltage	Referenced to GND		-0.2		0.6	٧	
I <sub>IL</sub> inhibit	Inhibit control (pin 4) Input low curent	Pin to GND			130		μΑ	
I <sub>IN</sub> inh	Input standby current	Inhibit control (pin 4) to GND			10		mA	
	Cuitabina franciana	Over V and L renge	PTH03060Y/PTH05060Y	250	300	350	ld I=	
f <sub>s</sub>	Switching frequency	Over V <sub>IN</sub> and I <sub>O</sub> ranges	PTH12060Y	200	250	300	kHz	
0	Estamolian de considera		PTH03060Y/PTH05060Y	330(3)				
C <sub>IN</sub>	External input capacitance		PTH12060Y	560			$\mu$ F	
	$ m C_{O}$ 1, $ m C_{O}$ 2 External output capacitance	Capacitance value: Nonceramic	PTH03060Y/PTH05060Y	470 (4)		5500 <sup>(5)</sup>		
			PTH12060Y	940(4)		5500 <sup>(5)</sup>	$\mu$ F	
C <sub>O</sub> 1, C <sub>O</sub> 2		Congoitanes value: Carami-	PTH03060Y/PTH05060Y		200(4)	300	μF	
		Capacitance value: Ceramic	PTH12060Y		400(4)	600		
		Equuivanent series resistance (no	Equuivanent series resistance (non-ceramic)				mΩ	
MTBF	Reliability	Per Bellcore TR-332 50 % stress,	T <sub>A</sub> = 40°C, ground benign	6			10 <sup>6</sup> Hrs	

- (1) Rating is conditional on the module being directly soldered to a 4-layer PCB with 1 oz. copper. See the SOA curves or contact the factory for appropriate derating.
- (2) This control pin has an internal pull-up to the input voltage V<sub>IN</sub>. If it is left open-circuit the module will operate when input power is applied. A small low-leakage (<100 nA) MOSFET is recommended for control. For further information, consult the related application note.
- (3) An input capacitor is required for proper operation. The capacitor must be rated for a minimum of 300 mA rms (750 mA rms for 12-V input) of ripple current.
- (4) The minimum value of external output capacitance value ensures that VTT meets the specified transient performance requirements for the memory bus terminations. Lower values of capacitance may be possible when the *measured* peak change in output current is consistently less than 3 A.
- (5) This is the calculated maximum. The minimum ESR limitation will often result in a lower value. Consult the capacitor application notes for further guidance.
- (6) This is the typical ESR for all the electrolytic (non-ceramic) output capacitance. Use 7 mΩ as the minimum when using max-ESR values to calculate.



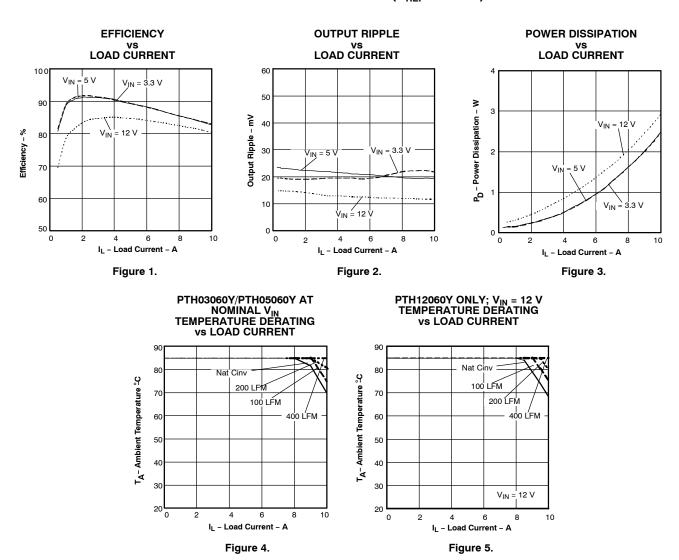
## **Terminal Functions**

TERMINAL		DECORIDEION							
NAME	NO.	DESCRIPTION							
V <sub>IN</sub>	2	The positive input voltage power node to the module, which is referenced to common GND.							
GND	1, 7	This is the common ground connection for the $V_{\text{IN}}$ and $V_{\text{TT}}$ power connections. It is also the 0-VDC reference for the control inputs.							
V <sub>REF</sub>	8	The module senses the voltage at this input to regulate the output voltage, $V_{TT}$ . The voltage at $V_{REF}$ is also the reference voltage for the system bus receiver comparators. It is normally set to precisely half the bus driver supply voltage ( $V_{DDQ}$ ÷ 2), using a resistor divider. The Thevenin impedance of the network driving the $V_{REF}$ pin should not exceed 500 $\Omega$ . See the Typical DDR Application Diagram in the Application Information section for reference.							
V <sub>TT</sub>	6	This is the regulated power output from the module with respect to the GND node, and the tracking termination supply for the application data and address buses. It is precisely regulated to the voltage applied to the module's V <sub>REF</sub> input, and is active active about 20 ms after a valid input source is applied to the module. Once active it will track the voltage applied at V <sub>REF</sub> .							
V <sub>o</sub> Sense	5	The sense input allows the regulation circuit to compensate for voltage drop between the module and the load. For optimal voltage accuracy $V_0$ Sense should be connected to $V_{TT}$ .							
Inhibit	3	The Inhibit pin is an open-collector/drain negative logic input that is referenced to GND. Applying a low-level ground signal to this input turns off the output voltage, V <sub>TT</sub> . Although the module is inhibited, a voltage, V <sub>DDQ</sub> will be present at the output terminals, fed through the DDR memory. When the Inhibit is active, the input current drawn by the regulator is significantly reduced. If the Inhibit pin is left open circuit, the module will produce an output whenever a valid input source is applied. See the Typical DDR Application Diagram in the Application Information section for reference.							
N/C	4, 9, 10	No connect							





## TYPICAL CHARACTERISTICS (V<sub>REF</sub> =1.25 V)(1)(2)



- (1) The electrical characteristic data has been developed from actual products tested at 25°C. This data is considered typical for the converter. Applies to Figure 1, Figure 2, and Figure 3.
- (2) The temperature derating curves represent the conditions at which internal components are at or below the manufacturer's maximum operating temperatures. Derating limits apply to modules soldered directly to a 4 in x 4 in double-sided PCB with 1 oz. copper. For surface mount packages (AS and AZ suffix), multiple vias (plated through holes) are required to add thermal paths around the power pins. Please refer to the mechanical specification for more information. Applies to Figure 4, and Figure 5.



#### **TYPICAL CHARACTERISTICS**

## TRANSIENT PERFORMANCE FOR $\Delta$ 3-A LOAD CHANGE

# PTH03060Y/PTH05060Y: SOURCE-SINK-SOURCE TRANSIENT

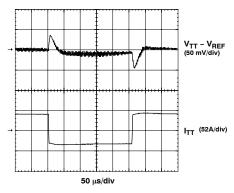


Figure 6.

#### PTH12060Y: SOURCE-SINK-SOURCE TRANSIENT

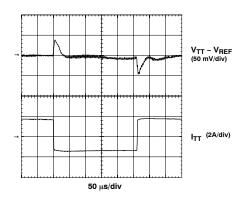
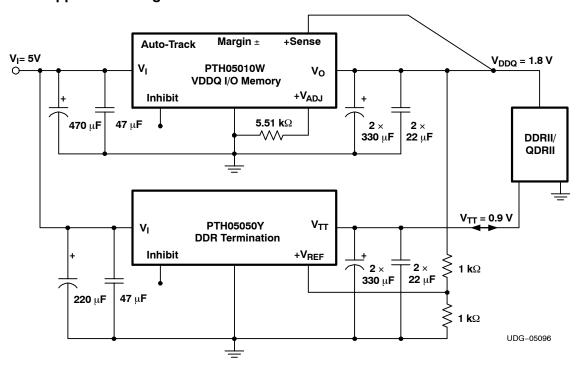


Figure 7.



#### **APPLICATION INFORMATION**

#### **Typical DDR Application Diagram**



# CAPACITOR RECOMMENDATIONS FOR THE PTH03060Y AND PTH05060Y DDR POWER MODULES (3.3-V/5-V OPTION)

#### **Input Capacitor**

The recommended input capacitor(s) is determined by the 330  $\mu$ F<sup>(1)</sup> minimum capacitance and 300 mArms minimum ripple current rating.

Ripple current and less than 160 m $\Omega$  equivalent series resistance (ESR) values are the major considerations, along with temperature, when designing with different types of capacitors. Unlike polymer tantalum, regular tantalum capacitors have a recommended minimum voltage rating of 2  $\times$  (maximum DC voltage + AC ripple). This is standard practice to insure reliability.

For improved ripple reduction on the input bus, ceramic capacitors may be substituted for electrolytic types using the minimum required capacitance.

#### **Output Capacitors**

For applications with load transients (sudden changes in load current), regulator response will benefit from external output capacitance. The recommended output capacitance of 470  $\mu$ F will allow the module to meet its transient response specification (see Electrical Specifications table). For most applications, a high quality computer-grade aluminum electrolytic capacitor is adequate. These capacitors provide decoupling over the frequency range, 2 kHz to 150 kHz, and are suitable when ambient temperatures are above 0°C. For operation below 0°C tantalum, ceramic or Os-Con type capacitors are recommended. When using one or more non-ceramic capacitors, the calculated equivalent ESR should be no lower than 4 m $\Omega$  (7 m $\Omega$  using the manufacturer's maximum ESR for a single capacitor). A list of preferred low-ESR type capacitors are identified in Table 1.



#### **APPLICATION INFORMATION (continued)**

#### **Ceramic Capacitors**

Above 150 kHz the performance of aluminum electrolytic capacitors becomes less effective. To further improve the reflected input ripple current or the output transient response. Multilayer ceramic capacitors have very low ESR and their resonant frequency higher than the bandwidth of the regulator. They can be used to reduce the reflected ripple current at the input as well as improve the transient response of the output. When used on the output their combined ESR is not critical as long as the total value of ceramic capacitance does not exceed  $300~\mu F$ . Also, to prevent the formation of local resonances, do not place more than five identical ceramic capacitors in parallel with values of  $10~\mu F$  or greater.

#### **Tantalum Capacitors**

Tantalum type capacitors can be used at both the input and output, and are recommended for applications where the ambient operating temperature can be less than 0°C. The AVX TPS, Sprague 593D/594/595 and Kemet T495/T510 capacitor series are suggested over many other tantalum types due to their higher rated surge, power dissipation, and ripple current capability. As a caution many general purpose tantalum capacitors have considerably higher ESR, reduced power dissipation and lower ripple current capability. These capacitors are also less reliable when determining their power dissipation and surge current rating. Tantalum capacitors that do not have a stated ESR or surge current rating are not recommended for power applications.

When specifying Os-Con and polymer tantalum capacitors for the output, the minimum ESR limit will be encountered well before the maximum capacitance value is reached.

#### **Capacitor Table**

Table 1 identifies the characteristics of capacitors from a number of vendors with acceptable ESR and ripple current (rms) ratings. The recommended number of capacitors required at both the input and output buses is identified for each capacitor type.

This is not an extensive capacitor list. Capacitors from other vendors are available with comparable specifications. Those listed are for guidance. The RMS ripple current rating and ESR (at 100 kHz) are critical parameters necessary to insure both optimum regulator performance and long capacitor life.

			Capacitor Cha	Qu	antity				
Capacitor Vendor, Type/Series (Style)	Working Value (µF)		Max ESR at 100 kHz (Ω)	Max Ripple Current at 85°C (Irms) (mA)	Physical Size (mm)	Input Bus	Output Bus	Vendor Part Number	
Panasonic, Aluminum									
FC (Radial)	10	470	0.117	555	8×11,5	1	1	EEUFC1A471	
FK (SMD)	10	470	0.160	600	8×10,2	1	1	EEVFK1A471P	
FC (SMD)	10	470	0.150	670	10×10,2	1	1	EEVFC1A471P	
United Chemi-Con									
PXA, Poly-Aluminum (SMD)	10	470	0.012	5300	10×12,2	1	≤1	PXA10VC471MJ12TP	
PS, Poly-Aluminum (Radial)	10	470	0.012	5300	8×12,2	1	≤1	10PS470MJ12	
LXZ, Aluminum (Radial)	10	470	0.120	555	8×12	1	1	LXZ10VB471M8X12LL	
Nichicon Aluminum									
WG (SMD)	10	470	0.150	670	10×10	1	1	UWG1A471MNR1GS	
HD (Radial)	10	470	0.072	760	8×11.5	1	1	UHD1A471MPR	
PM (Radial)	16	330	0.120	625	10×12,5	1	2	UPM1C331MPH6	

Table 1. Input/Output Capacitors (1)

#### (1) Capacitor Supplier Verification

Please verify availability of capacitors identified in this table. Capacitor suppliers may recommend alternative part numbers because of limited availability or obsolete products. In some instances, the capacitor product life cycle may be in decline and have short-term consideration for obsolescence.

#### RoHS, Lead-free and Material Details

Please consult capacitor suppliers regarding material composition, RoHS status, lead-free status, and manufacturing process requirements. Component designators or part number deviations can occur when material composition or soldering requirements are updated.



### **APPLICATION INFORMATION (continued)**

#### Table 1. Input/Output Capacitors (continued)

			Capacitor Cha	racteristics		Qu	antity		
Capacitor Vendor, Type/Series (Style)	Working Value (μF)		Max ESR at 100 kHz (Ω)	Max Ripple Current at 85°C (Irms) (mA)	Physical Size (mm)	Input Bus	Output Bus	Vendor Part Number	
Panasonic, Poly-Aluminum:									
S/SE (SMD)	6.3	180	0.005	4000	7,.3×4,3×4,2	2	N/R (2)	EEFSE0J181R	
Sanyo									
SEPC, Os-con (Radial)	16	470	0.010	6100	10×13	1	≤1	16SEPC470M	
SVP (SMD)	6.3	470	0.015	4210	8×11,9	1	≤2	6SVP470M	
TPE, Poscap (SMD)	6.3	330	0.025	2400	7.3×4.3	1	≤3	6TPE330ML	
AVX, Tantalum									
TPS Series III	10	470	0.045	1915	7.3L ×5.7W ×4.1H	1	≤5	TPSE477M010R0045	
TPS (SMD)	10	470	0.100	1432	A4.111	1	≤5	TPSV477M010R0100	
Kemet, Poly-Tantalum									
T520 (SMD)	10	330	0.040	1800	4.3W ×7.3L ×4.0H	1	1	T520X337M010AS	
T530 (SMD)	10	330	0.010	>5200	X4.011	1	≤1	T530X337M010ASE010	
Vishay-Sprague									
595D, Tantalum (SMD)	10	330	0.100	1040		1	≤5	595D377x0010D2T	
594D, Tantalum (SMD)	10	330	0.045	2360		1	≤5	594D337X0016R2T	
94SA,Poly-Aluminum (SMD)	6.3	330	0.025	3500	7.2L×6W ×4.1H	1	≤3	94SA337X06R3FBP	
94SVP, Poly-Aluminum (SMD)	6.3	470	0.017	3960	10 ×10,5 8,3x12	1	≤2	94SVP477X06R3E12	
Kemet, Ceramic X5R (SMD)	16	10	0.002	_	3225 mm	1	≤5	C1210C106M4PAC	
	6.3	47	0.002		3225 mm	1	≤5	C1210C476K9PAC	
Murata, Ceramic X5R (SMD)	6.3	100	0.002	_	3225 mm	1 <sup>(3)</sup>	≤3	GRM32ER60J107M	
	6.3	47			3225 mm	1 <sup>(3)</sup>	≤5	GRM32ER60J476M	
	16	22				1 <sup>(3)</sup>	≤5	GRM32ER61C226K	
	16	10				1 <sup>(3)</sup>	≤5	GRM32DR61C106K	
TDK, Ceramic X5R (SMD)	6.3	100	0.002	_	3225 mm	1 (3)	≤3	C3225X5R0J107MT	
	6.3	47			3225 mm	1 <sup>(3)</sup>	≤5	C3225X5R0J476MT	
	16	22				1 <sup>(3)</sup>	≤5	C3225X5R1C226MT	
	16	10				1 <sup>(3)</sup>	≤5	C3225X5R1C106MT	

<sup>(2)</sup> N/R – Not recommended. The capacitor does not meet the minimum operating limits.

#### **Designing for Very Fast Load Transients**

The transient response of the DC/DC converter has been characterized using a load transient with a di/dt of 1 A/ $\mu$ s. The typical voltage deviation for this load transient is given in the data sheet specification table using the optional value of output capacitance. As the di/dt of a transient is increased, the response of a converter's regulation circuit ultimately depends on its output capacitor decoupling network. This is an inherent limitation with any DC/DC converter once the speed of the transient exceeds its bandwidth capability. If the target application specifies a higher di/dt or lower voltage deviation, the requirement can only be met with additional output capacitor decoupling. In these cases special attention must be paid to the type, value and ESR of the capacitors selected.

If the transient performance requirements exceed that specified in the data sheet, or the total amount of load capacitance is above 5500  $\mu$ F, the selection of output capacitors becomes more important.

<sup>(3)</sup> A ceramic capacitor may be used to compliment electrolytic types at the input to further reduce high-frequency ripple current.

SLTS222A-MARCH 2004-REVISED OCTOBER 2005



CAPACITOR RECOMMENDATIONS FOR THE PTH12060Y DDR POWER MODULES (12-V OPTION)

#### Input Capacitor

The recommended input capacitance is determined by the 560  $\mu$ F <sup>[1]</sup> minimum capacitance and 750 mArms minimum ripple current rating. A 10- $\mu$ F X5R/X7R ceramic capacitor can be added to reduce the reflected input ripple current. The ceramic capacitor should be located between the input electrolytic and the module.

Ripple current, less than 100 m $\Omega$  equivalent series resistance (ESR) and temperature, are major considerations when selecting input capacitors. Unlike polymer-tantalum capacitors, regular tantalum capacitors have a recommended minimum voltage rating of 2 × (max. dc voltage + ac ripple). No tantalum capacitors were found with sufficient voltage rating to meet this requirement. At temperatures below 0°C, the ESR of aluminum electrolytic capacitors increases. For these applications, Os-Con, polymer-tantalum, and polymer-aluminum types should be considered.

#### **Output Capacitors**

For applications with load transients (sudden changes in load current), regulator response will benefit from external output capacitance. The recommended output capacitance of  $940\mu\text{F}$  will allow the module to meet its transient response specification (See Electrical Specifications table). For most applications, a high quality, computer-grade aluminum electrolytic capacitor is adequate. These capacitors provide decoupling over the frequency range, 2 kHz to 150 kHz, and are suitable for ambient temperatures above 0°C. Below 0°C, tantalum, ceramic, or Os-Con type capacitors are recommended. When using one or more nonceramic capacitors, the calculated equivalent ESR should be no lower than 4 m $\Omega$  (7 m $\Omega$  using the manufacturer's maximum ESR for a single capacitor).

A list of preferred low-ESR type capacitors are identified in Table 2.

In addition to electrolytic capacitance, adding a  $10-\mu\text{F}$  to  $22-\mu\text{F}$  X5R/X7R ceramic capacitor to the output reduces the output ripple voltage and improves the regulator's transient response. The measurement of both the output ripple and transient response is also best achieved across a  $10-\mu\text{F}$  ceramic capacitor.

#### Ceramic Capacitors

Above 150 kHz, the performance of aluminum electrolytic capacitors is less effective. Multilayer ceramic capacitors have a low ESR and a resonant frequency higher than the bandwidth of the regulator. They can be used to reduce the reflected ripple current at the input, and improve the transient response of the output. When used on the output, their combined ESR is not critical as long as the total value of ceramic capacitance does not exceed  $600 \, \mu F$ . Also, to prevent the formation of local resonances, do not place more than five identical ceramic capacitors in parallel with values of  $10 \, \mu F$  or greater.

#### Tantalum Capacitors

Tantalum type capacitors are most suited for use on the output bus, and are recommended for applications where the ambient operating temperature can be less than 0°C. The AVX TPS, Sprague 593D/594/595, and Kemet T495/T510 capacitor series are suggested over other tantalum types due to their higher rated surge, power dissipation, and ripple current capability. As a caution, many general-purpose tantalum capacitors have considerably higher ESR, reduced power dissipation, and lower ripple current capability. These capacitors are also less reliable as they have lower power dissipation and surge current ratings. Tantalum capacitors that do not have a stated ESR or surge current rating are not recommended for power applications.

When specifying Os-con and polymer tantalum capacitors for the output, the minimum ESR limit is encountered well before the maximum capacitance value is reached.

#### Capacitor Table

Table 2 identifies the characteristics of capacitors from a number of vendors with acceptable ESR and ripple current (rms) ratings. The recommended number of capacitors required at both the input and output buses is identified for each capacitor type.

Note: This is not an extensive capacitor list. Capacitors from other vendors are available with comparable specifications. Those listed are for guidance. The RMS ripple current rating and ESR (at 100 kHz) are critical parameters necessary to insure both optimum regulator performance and long capacitor life.



#### Designing for Very Fast Load Transients

The transient response of the dc/dc converter is characterized using a load transient with a di/dt of 1 A/ $\mu$ s. The typical voltage deviation for this load transient is given in the data sheet specification table using the optional value of output capacitance. As the di/dt of a transient is increased, the response of a converter's regulation circuit ultimately depends on its output capacitor decoupling network. This is an inherent limitation with any dc/dc converter once the speed of the transient exceeds its bandwidth capability. If the target application specifies a higher di/dt or lower voltage deviation, the requirement is met with additional output capacitor decoupling. In these cases, special attention must be paid to the type, value, and ESR of the capacitors selected.

If the transient performance requirements exceed that specified in this data sheet, or the total amount of load capacitance is above 5500  $\mu$ F, the selection of output capacitors becomes more important.

Table 2. Input/Output Capacitors (1)

			Capacitor Char	acteristics		Qua	antity	
Capacitor Vendor, Type/Series (Style)	Working Voltage (V)	Value (µF)	Max ESR at 100 kHz (Ω)	Max Ripple Current at 85°C (Irms) (mA)	Physical Size (mm)	Input Bus	Output Bus	Vendor Number
Panasonic, Aluminum	25	560	0.065	1205	12,5 × 15	1	1	EEUFC1E561S
FC (Radial)	25	1000	0.060	1100	12,5 × 13,5	1	1	EEVFK1E102Q
FK (SMD)	35	680	0.060	1100	12,5 × 13,5	1	1	EEVFK1V681Q
United Chemi-Con								
LXZ, Aluminum (Radial)	16	330	0.0014	5050	10 × 12,5	2	≤2	16PS330MJ12
PS, Poly-Aluminum (Radial)	16	680	0.068	1050	10 × 16	1	1	LXZ16VB681M10X16LL
PXA, Poly-Aluminum (SMD)	16	330	0.014	5050	10 × 12,2	2	≤2	PXA16VC331MJ12
Nichicon Aluminum	25	560	0.060	1060	12,5 × 15	1	1	UPM1E561MHH6
PM (Radial)	16	680	0.038	1430	10 × 16	1	1	UHD1C681MHR
HD (Radial)	35	560	0.048	1360	16 × 15	1	1	UPM1V561MHH6
Sanyo								
TPE, pos-cap (SMD)	10	330	0.025	3000	7,3 L × 5,7 W	N/R (2)	≤3	10TPE330M
SEPC, Os-con (Radial)	16	270	0.011	5000	8 × 12	2(3)	≤1	16SP270M
SVP, Os-con (SMD)	16	330	0.016	4700	11 × 12	2	≤2	16SVP330M
SVPC, Os-con (SMD)	4	1200	0.010	4700	8 × 11,9	N/R (2)	≤1	4SVPC1200M
AVX, Tantalum								
TPS Series III (SMD)	10	470	0.045	>1723	7,3 L× 5,7 W ×4,1H	N/R (2)	≤5	TPSE477M019R0045
TPS (SMD)	10	330	0.045	>1723	7,3 L ×4,3 W ×4,3 H	N/R (2)	≤5	TPSE337M019R0045
Kemet								
T520, Poly-Tantalum ( SMD)	10	470	0.040	1800	7,3 L ×4,3 W ×4,3 H	N/R <sup>(2)</sup>	≤5	T520X477M006ASE040
T530, Tantalum/Organic (SMD)	4	680	0.010	>5100	7,3 L ×4,3 W ×4,3 H	N/R (2)	≤1	T530X687M004ASE010
	6.3	470	0.010	5200	7,3 L ×4,3 W ×4,3 H	N/R (2)	≤1	T530X477M006ASE010
Vishay-Sprague								
594D, Tantalum (SMD)	10	470	0.100	1440	7,2 L ×6 W× 4,1 H	N/R (2)	≤5	595D477X0010R2T
94SA, organic (Radial )	16	1000	0.015	>9700	16 × 25	1	≤2	94Sa108X0016HBP
94SVP, Organic (SMD)	16	330	0.017	>4500	10 × 12,7	2	≤2	94SVP477X0016F12

#### (1) Capacitor Supplier Verification

Please verify availability of capacitors identified in this table. Capacitor suppliers may recommend alternative part numbers because of limited availability or obsolete products. In some instances, the capacitor product life cycle may be in decline and have short-term consideration for obsolescence.

#### RoHS, Lead-free and Material Details

Please consult capacitor suppliers regarding material composition, RoHS status, lead-free status, and manufacturing process requirements. Component designators or part number deviations can occur when material composition or soldering requirements are updated.

- 2) N/R Not recommended. The capacitor voltage rating does not meet the minimum operating limits.
- (3) A total capacitance of 540  $\mu$ F is acceptable based on the combined ripple current rating.



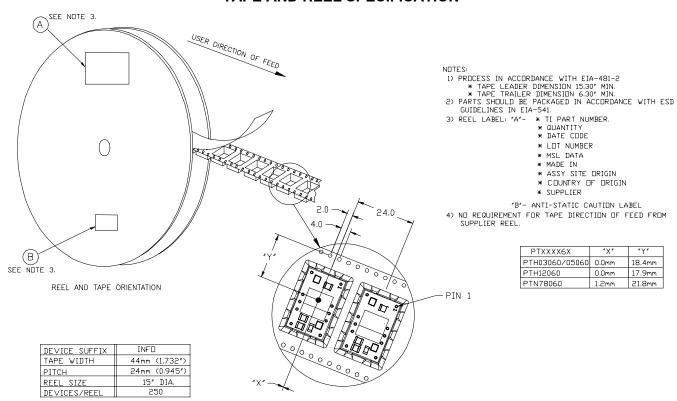
## Table 2. Input/Output Capacitors (continued)

			Capacitor Char	acteristics		Quantity			
Capacitor Vendor, Type/Series (Style)	Working Voltage (V)	Value (µF)	Max ESR at 100 kHz (Ω)	Max Ripple Current at 85°C (Irms) (mA)	Physical Size (mm)	Input Bus	Output Bus	Vendor Number	
Kemet, Ceramic X5R (SMD)	16	10	0.002		3225 mm	1 (4)	≤5	C1210C106M4PAC	
	6.3	47	0.002		3225 mm	N/R <sup>(2)</sup>	≤5	C1210C476K9PAC	
Murata, Ceramic X5R (SMD)	6.3	100	0.002		3225 mm	N/R (2)	≤4	GRM32ER60J107M	
	6.3	47			3225 mm	N/R <sup>(2)</sup>	≤5	GRM32ER60J476M	
	16	22				1 (4)	≤5	GRM32ER61C226K	
	16	10				1 (4)	≤5	GRM32DR61C106K	
TDK, Ceramic X5R (SMD)	6.3	100	0.002		3225 mm	N/R <sup>(2)</sup>	≤4	C3225X5R0J107MT	
	6.3	47			3225 mm	N/R <sup>(2)</sup>	≤5	C3225X5R0J476MT	
	16	22				1 (4)	≤5	C3225X5R1C226MT	
	16	10				1 (4)	≤5	C3225X5R1C106MT	

<sup>(4)</sup> Ceramic capacitors are recommended to complement electrolytic types at the input bus by reducing high-frequency ripple current.

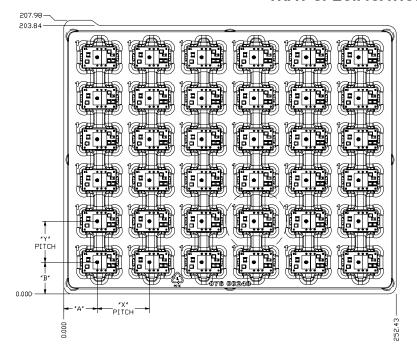


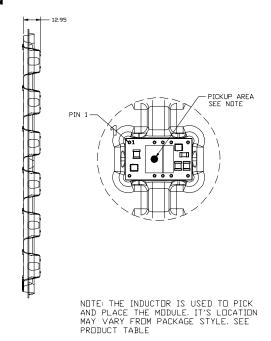
#### TAPE AND REEL SPECIFICATION





#### TRAY SPECIFICATION





PTXXXX6X	"A"	"B"	"X"	"Y"
PTH03060/05060	25.46	24.13	20.52	31.12
PTH12060	24.66	24.13	39.52	31.12
PTN78060	28.61	25.35		
ALL DIMENSIONS	ARE IN MIL	LIMETER.		

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#### **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
PTH03060YAH	ACTIVE	Through- Hole Module	EUW	10	36	RoHS Exempt & Green	SN	N / A for Pkg Type	-40 to 85		Samples
PTH03060YAST	ACTIVE	Surface Mount Module	EUY	10	250	Non-RoHS & Green	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH03060YAZT	ACTIVE	Surface Mount Module	EUY	10	250	RoHS Exempt & Green	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples
PTH05060YAH	ACTIVE	Through- Hole Module	EUW	10	36	RoHS Exempt & Green	SN	N / A for Pkg Type	-40 to 85		Samples
PTH05060YAS	ACTIVE	Surface Mount Module	EUY	10	36	Non-RoHS & Green	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH12060YAH	ACTIVE	Through- Hole Module	EUW	10	36	RoHS Exempt & Green	SN	N / A for Pkg Type	-40 to 85		Samples
PTH12060YAST	ACTIVE	Surface Mount Module	EUY	10	250	Non-RoHS & Green	SNPB	Level-1-235C-UNLIM/ Level-3-260C-168HRS	-40 to 85		Samples
PTH12060YAZ	ACTIVE	Surface Mount Module	EUY	10	36	RoHS (In Work) & Green	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples
PTH12060YAZT	ACTIVE	Surface Mount Module	EUY	10	250	RoHS Exempt & Green	SNAGCU	Level-3-260C-168 HR	-40 to 85		Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



## PACKAGE OPTION ADDENDUM

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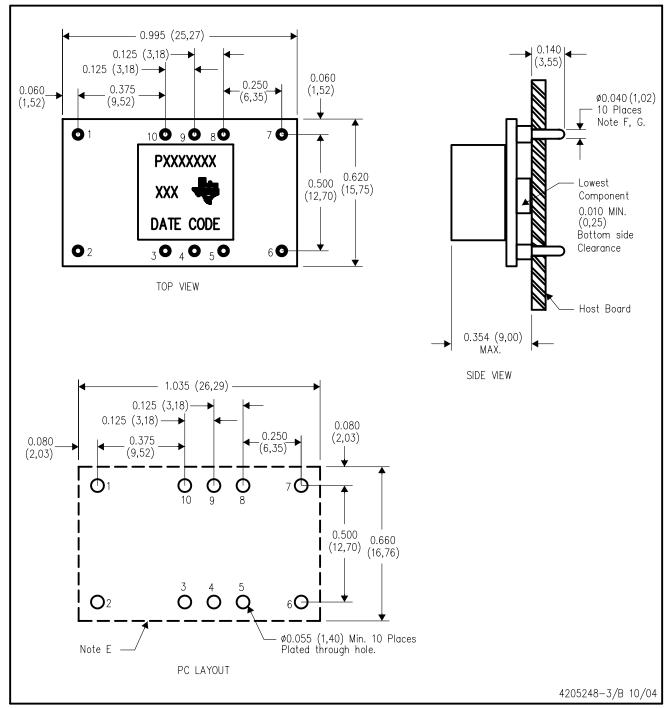
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## EUW (R-PDSS-T10)

## DOUBLE SIDED MODULE



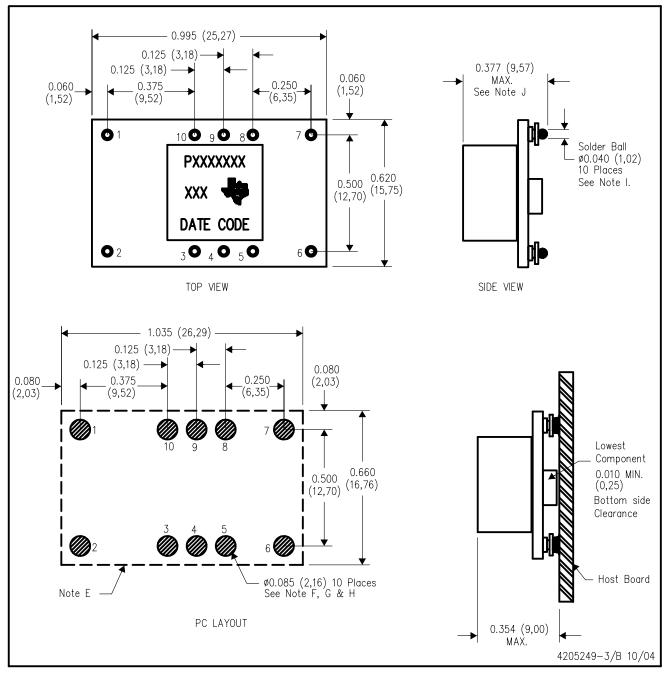
NOTES:

- All linear dimensions are in inches (mm). This drawing is subject to change without notice.
- 2 place decimals are  $\pm 0.030$  ( $\pm 0.76$ mm). 3 place decimals are  $\pm 0.010$  ( $\pm 0.25$ mm).
- Recommended keep out area for user components
- F. Pins are 0.040" (1,02) diameter with 0.070" (1,78) diameter standoff shoulder.
- G. All pins: Material Copper Alloy Finish - Tin (100%) over Nickel plate



## EUY (R-PDSS-B10)

## DOUBLE SIDED MODULE



NOTES: A. B.

All linear dimensions are in inches (mm). This drawing is subject to change without notice.

- 2 place decimals are  $\pm 0.030~(\pm 0.76$ mm). 3 place decimals are  $\pm 0.010~(\pm 0.25$ mm).
- E. Recommended keep out area for user components.
- F. Power pin connection should utilize two or more vias to the interior power plane of 0.025 (0,63) I.D. per input, ground and output pin (or the electrical equivalent).
- G. Paste screen opening: 0.080 (2,03) to 0.085 (2,16). Paste screen thickness: 0.006 (0,15).
- H. Pad type: Solder mask defined.
- I. All pins: Material Copper Alloy Finish — Tin (100%) over Nickel plate Solder Ball — See product data sheet.
- J. Dimension prior to reflow solder.



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